

Maximum Rating

Operating Temperature	-40°C~+85°C
Storage Temperature	-40°C~+85°C
RF Input Power	3W (CW) at 25°C

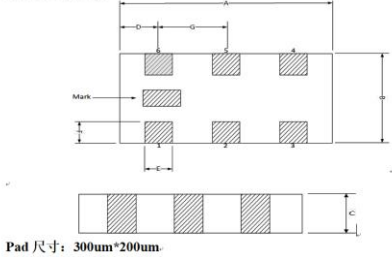
Pin Connections

PIN	Description
1	Unbalanced port(IN)
2	GND or DC feed +RF GND
3	Balanced Port
4	Balanced Port
5	GND
6	N.C.

Dimension & Layout

Max Length--L(mm)	2.0±0.15
Max Width--W(mm)	1.25±0.15
Max Height--H(mm)	0.90±0.05
Package	SMD

Layout Drawing



Symbol	Distance (mm)	Description
A	2.00	Length of the chip
B	1.25	Width of the chip
C	0.90	Height of the chip
D	0.35	Distance from pin 6 center to chip edge
E	0.3	Length of pins
F	0.2	Width of pins
G	0.65	Center distance of pins

Features

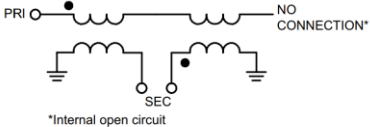
- Multilayer LTCC Technology.
- Miniatured Size L*W*H: 2.0x1.25x0.9mm
- New circuit topology for excellent return loss and low insertion loss
- High balance performance on LTCC Technology
- LTCC Structure

Application

- Applied to GSM、TDMA、PDC、WAN、TACS、AMPS、NAMPS navigation.



RoHS Compliant



Functional Schematic

Electrical Specifications⁽¹⁾ at 25°C

Parameter	MIN	Typ.	MAX	Unit
Frequency Range	350		470	MHz
Insertion Loss	-	-	1.2	dB
Return Loss	10	-	-	dB
Input/output Impedance	-	50/200	-	Ω
Differential Port Amplitude Balance	-	-	0.8	dB
Differential Port Phase Balance	-	-	8	Degree

(1) Measured on Characterization Test Board

Notes

- a. The specifications are tested at 25°C±5°C, relative humidity 55~75%.
b. Other quality and characteristic not specify in this datasheet.
Please contact us for detail requirements.

